

# ANTREX Electronics

## Electronic Components Sourcing Information

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### Product Reference Information

|                      |                           |
|----------------------|---------------------------|
| <b>Part Number:</b>  | SUP70090E-GE3             |
| <b>Manufacturer:</b> | Vishay Siliconix          |
| <b>Package:</b>      | Please confirm with sales |
| <b>Availability:</b> | Please confirm with sales |

#### Product Page:

<https://antrexco.com/product/details/vishay-siliconix/sup70090e-ge3.html>

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#### Note:

This PDF includes an ANTREX product reference cover page.

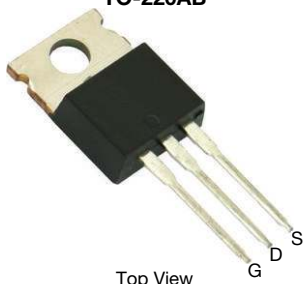
The original manufacturer datasheet follows from the next page.

# N-Channel 100 V (D-S) MOSFET

## PRODUCT SUMMARY

| V <sub>DS</sub> (V) | R <sub>DS(on)</sub> (Ω) MAX.      | I <sub>D</sub> (A) <sup>c</sup> | Q <sub>g</sub> (TYP.) |
|---------------------|-----------------------------------|---------------------------------|-----------------------|
| 100                 | 0.0089 at V <sub>GS</sub> = 10 V  | 50                              | 33 nC                 |
|                     | 0.0093 at V <sub>GS</sub> = 7.5 V | 50                              |                       |

TO-220AB



Top View

## Ordering Information:

SUP70090E-GE3 (lead (Pb)-free and halogen-free)

## FEATURES

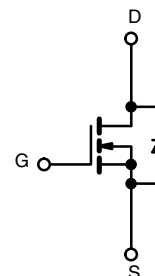
- ThunderFET® power MOSFET
- Maximum 175 °C junction temperature
- Q<sub>gd</sub> / Q<sub>gs</sub> ratio < 1 optimizes switching characteristics
- 100 % R<sub>g</sub> and UIS tested
- Material categorization:  
for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)

## APPLICATIONS

- Power supply  
- Secondary synchronous rectification
- DC/DC converter
- Power tools
- Motor drive switch
- DC/AC inverter



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**



N-Channel MOSFET

## ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25 °C, unless otherwise noted)

| PARAMETER                                          |                                     | SYMBOL                            | LIMIT       | UNIT |
|----------------------------------------------------|-------------------------------------|-----------------------------------|-------------|------|
| Drain-Source Voltage                               |                                     | V <sub>DS</sub>                   | 100         | V    |
| Gate-Source Voltage                                |                                     | V <sub>GS</sub>                   | ± 20        |      |
| Continuous Drain Current (T <sub>J</sub> = 150 °C) | T <sub>C</sub> = 25 °C              | I <sub>D</sub>                    | 50 °        | A    |
|                                                    | T <sub>C</sub> = 70 °C              |                                   | 50 °        |      |
| Pulsed Drain Current (t = 100 μs)                  |                                     | I <sub>DM</sub>                   | 120         |      |
| Avalanche Current                                  |                                     | I <sub>AS</sub>                   | 40          |      |
| Single Avalanche Energy <sup>a</sup>               | L = 0.1 mH                          | E <sub>AS</sub>                   | 80          | mJ   |
| Maximum Power Dissipation <sup>a</sup>             | T <sub>C</sub> = 25 °C              | P <sub>D</sub>                    | 125         | W    |
|                                                    | T <sub>C</sub> = 70 °C <sup>b</sup> |                                   | 87.5        |      |
| Operating Junction and Storage Temperature Range   |                                     | T <sub>J</sub> , T <sub>stg</sub> | -55 to +175 | °C   |

## THERMAL RESISTANCE RATINGS

| PARAMETER                                    | SYMBOL            | LIMIT | UNIT |
|----------------------------------------------|-------------------|-------|------|
| Junction-to-Ambient (PCB Mount) <sup>b</sup> | R <sub>thJA</sub> | 40    | °C/W |
| Junction-to-Case (Drain)                     | R <sub>thJC</sub> | 1.2   |      |

## Notes

- Duty cycle ≤ 1 %.
- When mounted on 1" square PCB (FR4 material).
- Package limited.

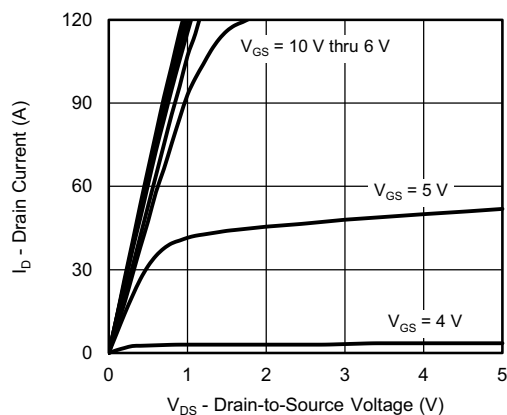
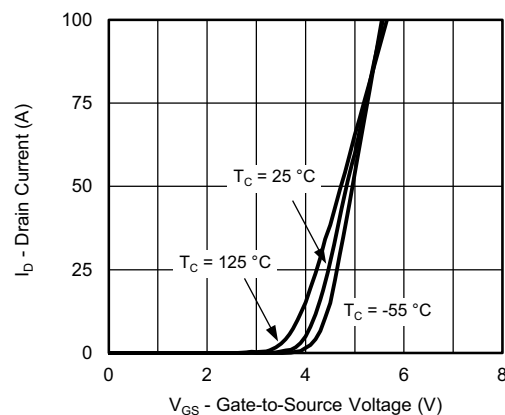
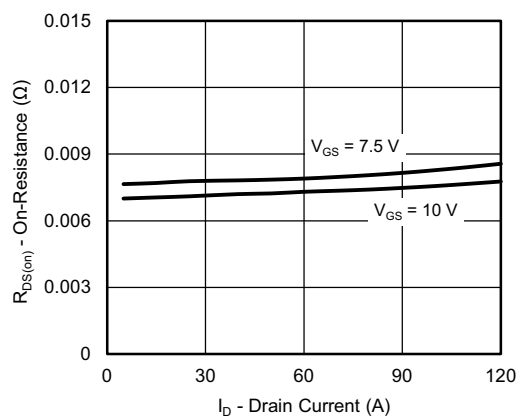
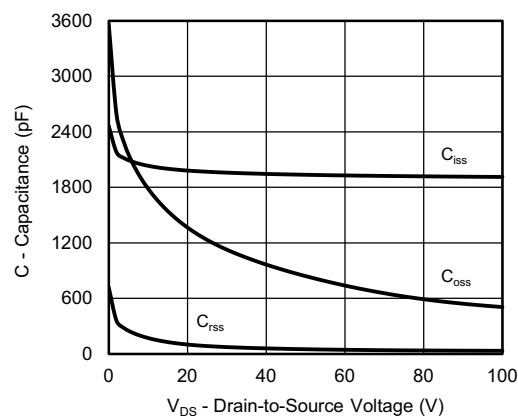
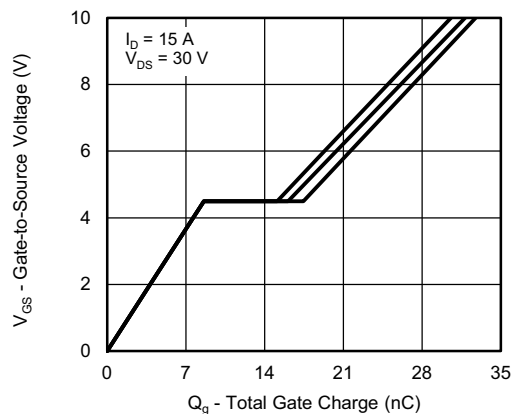
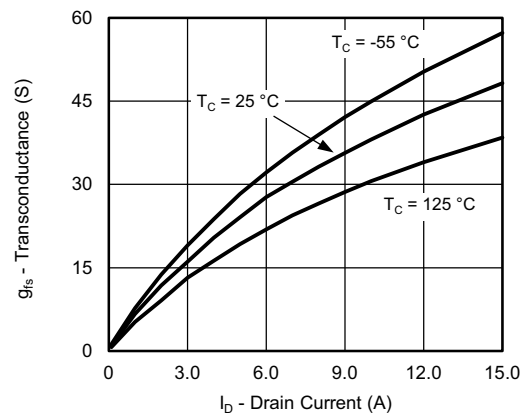


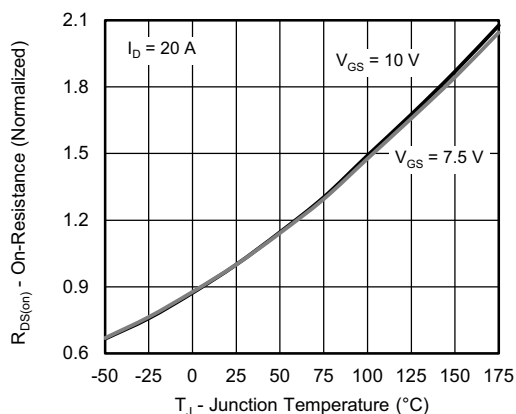
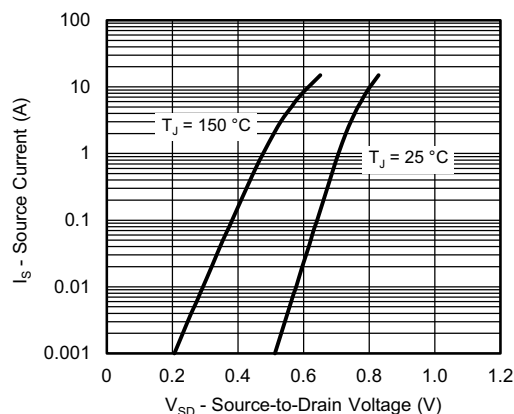
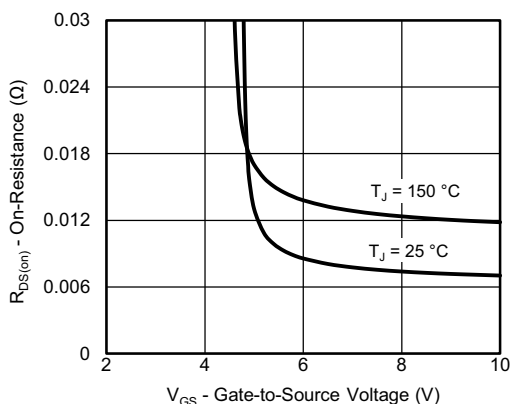
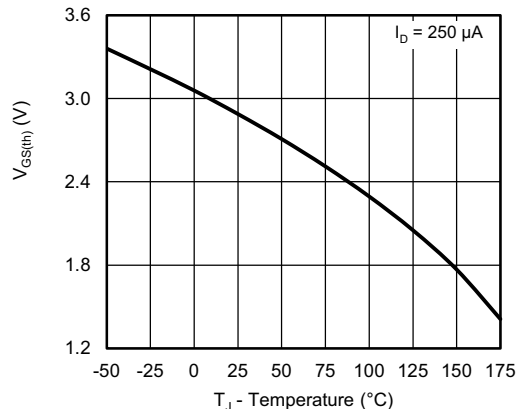
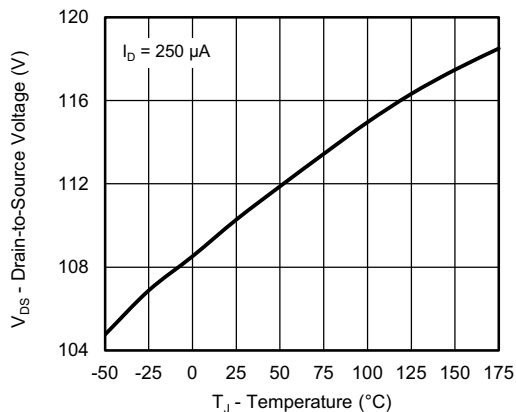
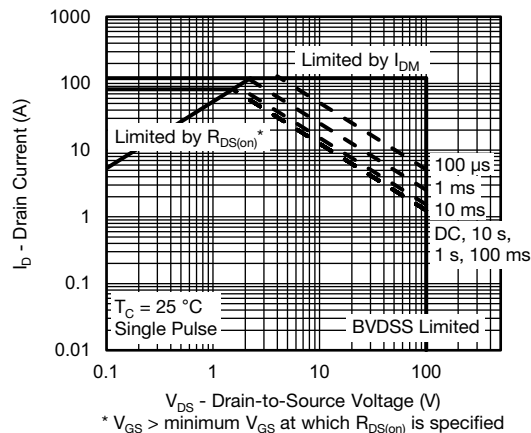
| SPECIFICATIONS (T <sub>J</sub> = 25 °C, unless otherwise noted)                           |                      |                                                                                                                      |      |        |        |      |
|-------------------------------------------------------------------------------------------|----------------------|----------------------------------------------------------------------------------------------------------------------|------|--------|--------|------|
| PARAMETER                                                                                 | SYMBOL               | TEST CONDITIONS                                                                                                      | MIN. | TYP.   | MAX.   | UNIT |
| Static                                                                                    |                      |                                                                                                                      |      |        |        |      |
| Drain-Source Breakdown Voltage                                                            | V <sub>DS</sub>      | V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA                                                                       | 100  | -      | -      | V    |
| Gate Threshold Voltage                                                                    | V <sub>GS(th)</sub>  | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA                                                          | 2    | -      | 4      |      |
| Gate-Body Leakage                                                                         | I <sub>GSS</sub>     | V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ± 20 V                                                                      | -    | -      | ± 250  | nA   |
| Zero Gate Voltage Drain Current                                                           | I <sub>DSS</sub>     | V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V                                                                       | -    | -      | 1      | μA   |
|                                                                                           |                      | V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C                                              | -    | -      | 150    |      |
|                                                                                           |                      | V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 175 °C                                              | -    | -      | 5      | mA   |
| On-State Drain Current <sup>a</sup>                                                       | I <sub>D(on)</sub>   | V <sub>DS</sub> ≥ 10 V, V <sub>GS</sub> = 10 V                                                                       | 50   | -      | -      | A    |
| Drain-Source On-State Resistance <sup>a</sup>                                             | R <sub>DS(on)</sub>  | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A                                                                        | -    | 0.0074 | 0.0089 | Ω    |
|                                                                                           |                      | V <sub>GS</sub> = 7.5 V, I <sub>D</sub> = 15 A                                                                       | -    | 0.0077 | 0.0093 |      |
| Forward Transconductance <sup>a</sup>                                                     | g <sub>fs</sub>      | V <sub>DS</sub> = 15 V, I <sub>D</sub> = 10 A                                                                        | -    | 38     | -      | S    |
| Dynamic <sup>b</sup>                                                                      |                      |                                                                                                                      |      |        |        |      |
| Input Capacitance                                                                         | C <sub>iss</sub>     | V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 50 V, f = 1 MHz                                                             | -    | 1950   | -      | pF   |
| Output Capacitance                                                                        | C <sub>oss</sub>     |                                                                                                                      | -    | 845    | -      |      |
| Reverse Transfer Capacitance                                                              | C <sub>rss</sub>     |                                                                                                                      | -    | 54     | -      |      |
| Total Gate Charge <sup>c</sup>                                                            | Q <sub>g</sub>       | V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A                                                | -    | 33     | 50     | nC   |
| Gate-Source Charge <sup>c</sup>                                                           | Q <sub>gs</sub>      |                                                                                                                      | -    | 8.8    | -      |      |
| Gate-Drain Charge <sup>c</sup>                                                            | Q <sub>gd</sub>      |                                                                                                                      | -    | 7.5    | -      |      |
| Gate Resistance                                                                           | R <sub>g</sub>       | f = 1 MHz                                                                                                            | 0.7  | 3.5    | 7      | Ω    |
| Turn-On Delay Time <sup>c</sup>                                                           | t <sub>d(on)</sub>   | V <sub>DD</sub> = 50 V, R <sub>L</sub> = 5 Ω<br>I <sub>D</sub> ≅ 10 A, V <sub>GEN</sub> = 10 V, R <sub>g</sub> = 1 Ω | -    | 15     | 30     | ns   |
| Rise Time <sup>c</sup>                                                                    | t <sub>r</sub>       |                                                                                                                      | -    | 27     | 54     |      |
| Turn-Off Delay Time <sup>c</sup>                                                          | t <sub>d(off)</sub>  |                                                                                                                      | -    | 36     | 72     |      |
| Fall Time <sup>c</sup>                                                                    | t <sub>f</sub>       |                                                                                                                      | -    | 45     | 90     |      |
| Drain-Source Body Diode Ratings and Characteristics <sup>b</sup> (T <sub>C</sub> = 25 °C) |                      |                                                                                                                      |      |        |        |      |
| Pulsed Current (t = 100 μs)                                                               | I <sub>SM</sub>      |                                                                                                                      | -    | -      | 120    | A    |
| Forward Voltage <sup>a</sup>                                                              | V <sub>SD</sub>      | I <sub>F</sub> = 10 A, V <sub>GS</sub> = 0 V                                                                         | -    | 0.8    | 1.5    | V    |
| Reverse Recovery Time                                                                     | t <sub>rr</sub>      | I <sub>F</sub> = -10 A, di/dt = 100 A/μs                                                                             | -    | 77     | 116    | ns   |
| Peak Reverse Recovery Charge                                                              | I <sub>RM(REC)</sub> |                                                                                                                      | -    | 4.2    | 6.3    | A    |
| Reverse Recovery Charge                                                                   | Q <sub>rr</sub>      |                                                                                                                      | -    | 145    | 365    | nC   |

**Notes**

- a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .  
b. Guaranteed by design, not subject to production testing.  
c. Independent of operating temperature.

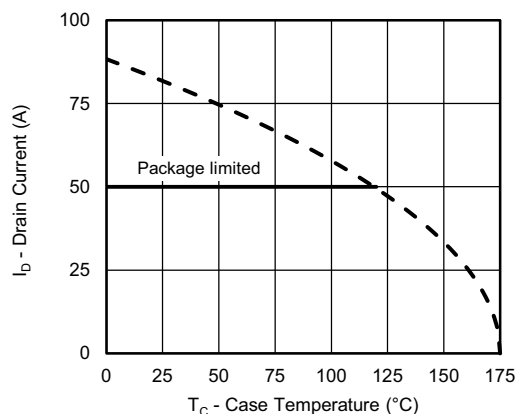
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**TYPICAL CHARACTERISTICS** ( $T_A = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted)

**Output Characteristics**

**Transfer Characteristics**

**On-Resistance vs. Drain Current**

**Capacitance**

**Gate Charge**

**Transconductance**

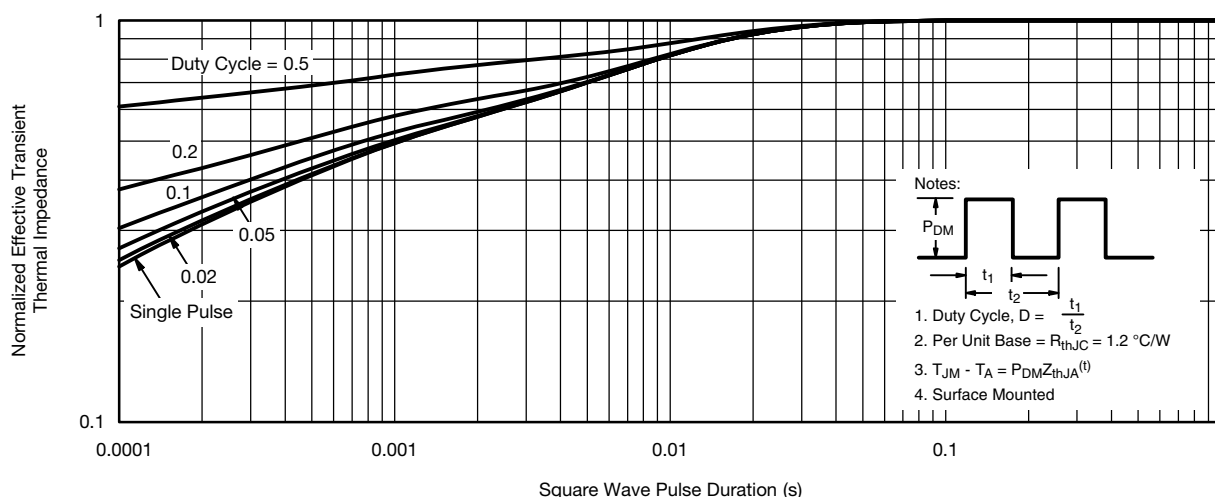
**TYPICAL CHARACTERISTICS** ( $T_A = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted)

**On-Resistance vs. Junction Temperature**

**Source Drain Diode Forward Voltage**

**On-Resistance vs. Gate-to-Source Voltage**

**Threshold Voltage**

**Drain Source Voltage vs. Junction Temperature**

**Safe Operating Area**



**THERMAL RATINGS** ( $T_A = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted)



**Current De-Rating**



**Normalized Thermal Transient Impedance, Junction-to-Case**

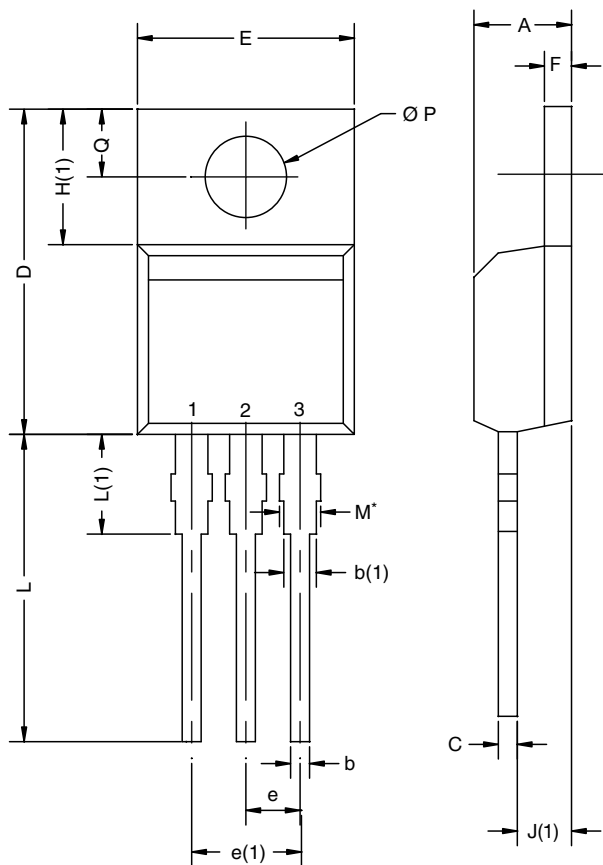
**Note**

- The characteristics shown in the two graphs
    - Normalized Transient Thermal Impedance Junction to Ambient ( $25\text{ }^{\circ}\text{C}$ )
    - Normalized Transient Thermal Impedance Junction to Case ( $25\text{ }^{\circ}\text{C}$ )
- are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see [www.vishay.com/ppg?65436](http://www.vishay.com/ppg?65436).



## TO-220AB

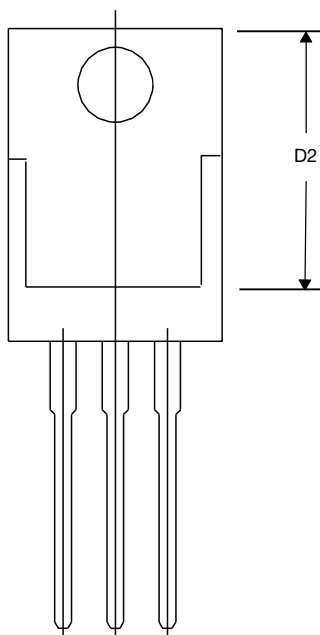


| DIM.            | MILLIMETERS |       | INCHES |       |
|-----------------|-------------|-------|--------|-------|
|                 | MIN.        | MAX.  | MIN.   | MAX.  |
| A               | 4.25        | 4.65  | 0.167  | 0.183 |
| b               | 0.69        | 1.01  | 0.027  | 0.040 |
| b(1)            | 1.20        | 1.73  | 0.047  | 0.068 |
| c               | 0.36        | 0.61  | 0.014  | 0.024 |
| D               | 14.85       | 15.49 | 0.585  | 0.610 |
| D2              | 12.19       | 12.70 | 0.480  | 0.500 |
| E               | 10.04       | 10.51 | 0.395  | 0.414 |
| e               | 2.41        | 2.67  | 0.095  | 0.105 |
| e(1)            | 4.88        | 5.28  | 0.192  | 0.208 |
| F               | 1.14        | 1.40  | 0.045  | 0.055 |
| H(1)            | 6.09        | 6.48  | 0.240  | 0.255 |
| J(1)            | 2.41        | 2.92  | 0.095  | 0.115 |
| L               | 13.35       | 14.02 | 0.526  | 0.552 |
| L(1)            | 3.32        | 3.82  | 0.131  | 0.150 |
| $\varnothing P$ | 3.54        | 3.94  | 0.139  | 0.155 |
| Q               | 2.60        | 3.00  | 0.102  | 0.118 |

ECN: T14-0413-Rev. P, 16-Jun-14  
DWG: 5471

**Note**

\*  $M = 1.32$  mm to  $1.62$  mm (dimension including protrusion)  
Heatsink hole for HVM





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